## B. Tech Degree V Semester Examination, November 2009

## EC/EI 505 MICRO ELECTRONICS AND INTEGRATED CIRCUITS

(2006 Scheme)

Time: 3 Hours		Maximu	m Marks: 100
PART - A			
		(Answer <u>ALL</u> questions)	$(8 \times 5 = 40)$
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I.	(a)	Define the following terms:	
		(i) Slew rate (ii) CMRR	
	(b)	Explain the working of integrator using op – amps.	
,	(c)	Draw and explain the circuit of an astable multivibrator.	
	(d)	Draw and explain the circuit of a peak detector.	
	(e)	Draw the block diagram of PLL and explain each block.	
	<b>(f)</b>	Explain the working of Flash – type ADC.	
	(g)	What are the advantages of ICs over discrete components?	
	(h)	Differentiate between hybrid and monolithic integrated circuits.	
PART – B			
			$(4 \times 15 = 60)$
11	(a)	Draw the circuit of an an amn investing amplifier. Derive the expressions	
П.	(a)	Draw the circuit of an op – amp inverting amplifier. Derive the expressions for voltage gain and input impedance.	(10)
	(b)	Explain virtual ground concept.	(5)
	(5)	OR	(-)
III.		Derive the expression for gain in an instrumentation amplifier.	(15)
IV.		Explain the working of RC phase - shift oscillator using op - amp. Derive the	
		expression for frequency of oscillation and gain.	(15)
		OR	
V.	(a)	Explain the working of Schmitt trigger and plot the transfer characteristics.	(8)
	(b)	Explain the working of all – pass filter.	(7)
VI.		Explain the functional block diagram of 555 timer. How it can be used as	
		monostable multivibrator.	(15)
		OR	
VII.	(a)	Explain the working of low voltage regulator using 723 IC.	(10)
	(b)	Explain the application of PLL as a frequency multiplier.	(5)
VIII.		Explain bipolar IC fabrication steps with neat sketches.	(15)
		OR	()
IX.		Explain thick film technology. Explain how resistors and capacitors can be	
		fabricated using thick film technology.	(15)
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